

2SK2642-01MR

FUJI POWER MOS-FET

N-CHANNEL SILICON POWER MOS-FET

■ Features

- ## High speed switching

- #### **Low on-resistance**

- ### No secondary breakdown

- ### Low driving power

- ### **High voltage**

- V_{GS}=+35V Guarantee

- ### Avalanche-proof

■ Applications

- ## **Switching regulators**

- UPS

- ### DC-DC converters

- ## General purpose power amplifier

■ Maximum ratings and characteristicAbsolute maximum ratings

($T_c=25^\circ\text{C}$, unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	V _{DS}	500	V
Continuous drain current	I _D	±15	A
Pulsed drain current	I _{D(puls)}	±60	A
Gate-source voltage	V _{GS}	±35	V
Maximum Avalanche Energy	E _{AV} *1	88.7	mJ
Max. power dissipation	P _D	50	W
Operating and storage temperature range	T _{ch}	+150	°C
	T _{stg}	-55 to +150	°C

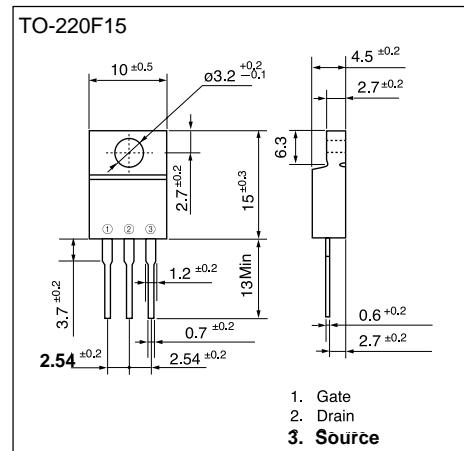
*1 L=0.72mH, Vcc=50V

● Electrical characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

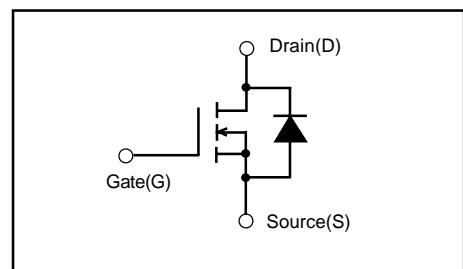
Electrical characteristics (T = 25 °C unless otherwise specified)		Test Conditions		Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id=1mA	VGS=0V	500			V
Gate threshold voltage	VGS(th)	Id=1mA	VDS=VGS	3.5	4.0	4.5	V
Zero gate voltage drain current	IDSS	VDS=500V VGS=0V		Tch=25°C	10	500	µA
				Tch=125°C	0.2	1.0	mA
Gate-source leakage current	IGSS	VGS=±35V VDS=0V			10	100	nA
Drain-source on-state resistance	RDS(on)	Id=7.5A VGS=10V			0.44	0.55	Ω
Forward transconductance	gfs	Id=7.5A VDS=25V			4.5	9.0	S
Input capacitance	Ciss	VDS=25V VGS=0V f=1MHz			1400	2100	pF
Output capacitance	Coss				250	380	
Reverse transfer capacitance	Crss				110	170	
Turn-on time ton	td(on)	Vcc=300V Id=15A VGS=10V RGS=10 Ω			30	50	ns
	tr				110	170	
Turn-off time toff	td(off)				90	140	
	tf				55	90	
Avalanche capability	IAV	L=100µH Tch=25°C			15		A
Diode forward on-voltage	VSD	If=2xID VGS=0V Tch=25°C			1.1	1.65	V
Reverse recovery time	trr	If=ID VGS=0V -di/dt=100A/µs Tch=25°C			500		ns
Reverse recovery charge	Qrr				8.0		µC

● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	R _{th(ch-c)}	channel to case			2.50	°C/W
	R _{th(ch-a)}	channel to ambient			62.5	°C/W



■ Equivalent circuit schematic



■ Characteristics

